

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization
International Bureau



(10) International Publication Number

WO 2015/023921 A1

(43) International Publication Date
19 February 2015 (19.02.2015)

WIPO | PCT

(51) International Patent Classification:
H01R 4/02 (2006.01) *H05B 3/84* (2006.01)
B60J 10/02 (2006.01)

(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BN, BR, BW, BY, BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IR, IS, JP, KE, KG, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PA, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW, SA, SC, SD, SE, SG, SK, SL, SM, ST, SV, SY, TH, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.

(21) International Application Number:
PCT/US2014/051216

(22) International Filing Date:
15 August 2014 (15.08.2014)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:
61/866,911 16 August 2013 (16.08.2013) US

(71) Applicants: AGC AUTOMOTIVE AMERICAS R&D, INC. [US/US]; 1401 South Huron Street, Ypsilanti, MI 48197-9701 (US). AGC FLAT GLASS NORTH AMERICA, INC.; 11175 Cicero Drive, Suite 400, Alpharetta, GA 30022 (US).

(72) Inventors: BENNETT, Daniel, D.; 603 Wing Ct., Tecumseh, MI 49286 (US). SCHUCH, William, C.; 2881 Mystic Hills, Adrian, MI 49221 (US).

(74) Agents: LAPRAIRIE, David, M. et al.; HOWARD & HOWARD ATTORNEY PLLC, 450 West Fourth Street, Royal Oak, MI 48067 (US).

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LR, LS, MW, MZ, NA, RW, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, RU, TJ, TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK, SM, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, KM, ML, MR, NE, SN, TD, TG).

Declarations under Rule 4.17:

— *of inventorship (Rule 4.17(iv))*

Published:

— *with international search report (Art. 21(3))*

[Continued on next page]

(54) Title: WINDOW ASSEMBLY WITH CASING FOR SOLDER JOINT

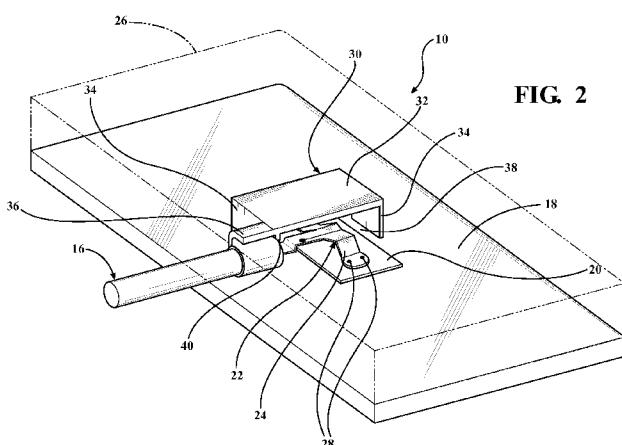


FIG. 2

(57) **Abstract:** A window assembly (10) includes a transparent pane (18), an electrical conductor (20) contacting the transparent pane (18), an electrical connection element (22) for energizing the electrical conductor (20), an electrically conductive solder joint (28) disposed between the electrical connection element (22) and the electrical conductor (20) for providing an electrical connection between the electrical connection element (22) and the electrical conductor (20), an encapsulation (26) over the electrical connection element (22) and the electrical conductor (20), and a casing (30) disposed between the encapsulation (26) and the electrical conductor (20) to prevent contact between the encapsulation (26) and the solder joint (28).



— *with amended claims and statement (Art. 19(1))*

WINDOW ASSEMBLY WITH CASING FOR SOLDER JOINT

CROSS-REFERENCE TO RELATED APPLICATION(S)

[0001] The present invention claims the priority date of co-pending United States Provisional Patent Application Serial Number 61/866,911, filed August 16, 2013.

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0002] The present invention relates generally to window assemblies, and more specifically to a window assembly with a casing for a solder joint.

2. Description of the Related Art

[0003] Window assemblies for vehicles are often functionalized to include a transparent pane having an electrical conductor bonded to a connection element through a solder joint. The electrical conductor typically includes a printed silver circuit. The printed silver circuit is disposed on a surface of the transparent pane contained within the window assembly. Typically, power is transferred through a wire harness to the printed silver circuit. The wire harness has an electrical connection element which is electrically coupled to the printed silver circuit through the solder joint.

[0004] The window assembly is often further functionalized to include additional components, such as frames, rails or guides. When the window assembly

includes additional components, an encapsulation may be utilized to attach these additional components to the window assembly. Typically, the encapsulation is made of a polymeric material disposed on the solder joint when the encapsulation is utilized to attach these additional components.

[0005] However, the window assembly is prone to a variety of unacceptable defects when the encapsulation is disposed on the solder joint. For example, the differences between the coefficients of thermal expansion of the solder joint, the transparent pane, and the encapsulation impart mechanical stress on the transparent pane, such that when the transparent pane is a glass pane, the glass pane is prone to cracking. The mechanical stress may also delaminate the printed silver circuit from the transparent pane or separate the solder joint from the printed silver circuit. Moreover, the mechanical stress may also crack the solder joint.

[0006] In another example, the encapsulation may permit water to contact the printed silver circuit near the solder joint. Water routinely penetrates through the encapsulation to contact the printed silver circuit near the solder joint. Water that has contacted the printed silver circuit near the solder joint is slow to evaporate because the water is disposed between the encapsulation and the printed silver circuit. As such, the water may corrode the printed silver circuit, thereby rendering the printed silver circuit inoperable. Accordingly, there remains an opportunity to develop an improved window assembly.

[0007] Accordingly, it is desirable to develop a window assembly that prevents the differences in the coefficients of thermal expansion between the transparent pane and the encapsulation from imparting a mechanical stress onto the transparent pane through the solder joint. It is also desirable to develop a window assembly that does not impart a mechanical stress onto a glass pane that may cause

the glass pane to crack. Additionally, it would be desirable to develop a window assembly that does not impart a mechanical stress onto the transparent pane that may separate the connection element and the terminal connector, thereby severing the electrical connection between the electrical conductor and the power supply. Therefore, there is a need in the art for a window assembly that meets at least one of these desires.

SUMMARY OF THE INVENTION

[0008] Accordingly, the present invention provides a window assembly including a transparent pane and an electrical conductor contacting the transparent pane. The window assembly also includes an electrical connection element for energizing the electrical conductor and an electrically conductive solder joint between the electrical connection element and the electrical conductor for providing an electrical connection between the electrical connection element and the electrical conductor. The window assembly further includes an encapsulation over the electrical connection element and the electrical conductor and a casing disposed between the encapsulation and the electrical conductor to prevent contact between the encapsulation and the solder joint.

[0009] One advantage of the present invention is that a new window assembly is provided with a casing to isolate an encapsulation from a solder joint because the transparent pane typically has a lower coefficient of thermal expansion than the encapsulation, such as when the transparent pane is glass. Another advantage of the present invention is that the window assembly provides a casing that isolates the solder joint from the encapsulation, in which no mechanical stress is imparted onto the transparent pane through the solder joint. Yet another advantage of the

present invention is that the window assembly includes a casing for the solder joint, resulting in the transparent pane not being prone to cracking or fracturing. Still another advantage of the present invention is that the window assembly includes a casing that seals the solder joint, preventing water from penetrating past the casing and contacting the solder joint. A further advantage of the present invention is that the window assembly includes a casing for a solder joint that is less prone to failure from mechanical stress and also less susceptible to corrosion.

[0010] Other features and advantages of the present invention will be readily appreciated, as the same become better understood, after reading the subsequent description taken in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0011] Figure 1 is an elevational view of one embodiment of a window assembly, according to the present invention, illustrated in operational relationship with a vehicle.

[0012] Figure 2 is a partial cross sectional perspective view of the window assembly of Figure 1 having a portion of a casing cut away.

[0013] Figure 3 is a planar top view of the window assembly of Figure 2 illustrated without an encapsulation.

[0014] Figure 4 is a front elevational view of the window assembly of Figure 2 illustrated without an encapsulation.

[0015] Figure 5 is a side elevational view of the window assembly of Figure 2 illustrated without an encapsulation.

DESCRIPTION OF THE PREFERRED EMBODIMENT(S)

[0016] Referring to the Figures, wherein like numerals indicate like parts throughout the several views, one embodiment of a window assembly 10, according to the present invention, is shown in Figures 1 and 2. The window assembly 10 is typically for a vehicle, generally indicated at 12, such as an automotive vehicle. As illustrated in Figure 1, the window assembly 10 may be a rear window assembly having a defrost system, generally indicated at 14. It should be appreciated that the window assembly 10 may be used for other types of vehicles providing a connection between a wiring harness, generally indicated at 16 (Figure 2), and the defrost system 14 or other components such as an antenna (not shown).

[0017] Referring to Figures 1 and 2, one embodiment of the window assembly 10, according to the present invention, includes a transparent pane 18. In one embodiment, the transparent pane 18 is made of glass. In another embodiment, the transparent pane 18 is made of a polymethyl methacrylate, polycarbonate, polyvinyl butyral, and the like. The window assembly 10 also includes an electrical conductor 20. In one embodiment, the electrical conductor 20 is made of silver. In other embodiments, the electrical conductor 20 may be made of other conductive metals and/or other conductive or nonconductive materials in addition to, or instead of, silver. The electrical conductor 20 may be a film, a coating, and/or in any other form so long as the electrical conductor 20 is conductive and serves any function known in the art for such electrical conductors. The electrical conductor 20 may be porous and/or nonporous. In various embodiments, the electrical conductor 20 is a porous silver film. In other embodiments, the electrical conductor 20 may be printed, for example, a printed silver film or printed silver circuit. It should be appreciated

that, although the electrical conductor 20 is shown to have a rectangular shape, the electrical conductor 20 may have any suitable shape.

[0018] In one embodiment, the electrical conductor 20 is disposed on the transparent pane 18 near a peripheral edge of the transparent pane 18. The electrical conductor 20 is often a component of a circuit, such as the defrost system 14, an antenna, a defogger, or the like. It should be appreciated that the electrical conductor 20 may be integral with the circuit or an extension of the circuit. The electrical conductor 20 may include one or more bus bars (not shown). It should be appreciated that the wire harness 16 transfers power from a power supply (not shown) to the electrical conductor 20.

[0019] The window assembly 10 also includes an electrical connection element, generally indicated at 22, that connects the wiring harness 16 and the electrical conductor 20 for electrically coupling and operatively connecting the electrical conductor 20 and the power supply. The connection element 22 is in electrical communication with the electrical conductor 20 for energizing the electrical conductor 20. In one embodiment, the connection element 22 may be of copper, a copper alloy, silver, a silver alloy, or combinations thereof. In other embodiments, the connection element 22 may also be of other metals in addition to or absent the metals described above, including, but not limited to, iron, molybdenum, tungsten, nickel, hafnium, tantalum, titanium, chromium, iridium, niobium, vanadium, platinum, tin, or combinations thereof. In one embodiment, the connection element 22 is copper. Typically, the connection element 22 includes a terminal connector 24 that is disposed at a distal end of the wiring harness 16. It should be appreciated that the connection element 22 may be of other conductive metals and/or other conductive or nonconductive material.

[0020] As illustrated in Figures 1 and 2, the window assembly 10 may include a layer or encapsulation 26 that encapsulates the peripheral edge of the window assembly 10. In one embodiment, the encapsulation 26 is made of a polymer or polymeric material. Non-limiting examples of the polymer include thermoplastic material(s) or thermoset material(s). Other non-limiting examples of the polymer include thermoplastic elastomers (TPE), thermoplastic vulcanizates (TPV), and thermoplastic polyolefins (TPO). Specific non-limiting examples include thermoplastic styrene (TPS), polyurethane, polyvinyl chloride (PVC), and ester based thermoplastic elastomers (E-TPE). It should be appreciated that, in one embodiment, the encapsulation 26 is formed from a reaction injection molding (RIM) process. It should also be appreciated that the encapsulation 26 may be made of non-polymeric materials.

[0021] The window assembly 10 may include one or more functional components (not shown) for aligning, positioning, or guiding the window assembly 10 on the vehicle 12. In one example, the functional component may be a rail for allowing the window assembly 10 to slide on a complementary rail attached to the vehicle 12. In another example, the functional component may be a frame for mounting the window assembly 10 to the vehicle 12. The encapsulation 26 attaches the functional components to the window assembly 10. To attach the functional component to the window assembly 10, the encapsulation 26 may encapsulate a portion of the functional component, thereby attaching the functional component to the window assembly 10.

[0022] In one embodiment, as specifically shown in Figures 2 through 5, the window assembly 10 includes a solder joint 28. The solder joint 28 connects the connection element 22 and the electrical conductor 20 for bonding and electrically

coupling the electrical conductor 20 and the connection element 22. As illustrated in the figures, the connection element 22 may include the terminal connector 24. In one embodiment, the solder joint 28 may be between the electrical conductor 20 and the terminal connector 24. In another embodiment, the solder joint 28 may contact the electrical conductor 20 and the terminal connector 24 on an exterior surface of the connection element 22 and an exterior surface of the electrical conductor 20. As such, the solder joint 28 electrically couples and operatively connects the electrical conductor 20 to the power supply. The solder joint 28 is made from metals and/or alloys formed from lead, indium, tin, copper, silver, bismuth, germanium, gallium, gold, and/or other conductive metals and non-metals.

[0023] In the embodiment illustrated, the window assembly 10 further includes a casing, generally indicated at 30, for isolating the solder joint 28 from the encapsulation 26 (not shown in Figures 3 through 5). Said differently, the casing 30 provides a physical barrier that surrounds the solder joint 28 and precludes contact between the solder joint 28 and the encapsulation 26. Notably, the casing 30 illustrated in Figures 2 through 5 has been partially removed so that the electrical conductor 20, the terminal connector 24, and the solder joint 28 are not obstructed from view in these figures. In the embodiment illustrated, the casing 30 is generally rectangular in shape. The casing 30 has a top wall 32 and side walls 34 extending downwardly from the top wall 32 to engage the transparent pane 18. The casing 30 has a tubular portion 36 extending from one of the side walls 34 to receive a portion of the wiring harness 16. It should be appreciated that the casing 30 can be any geometric shape so long as the geometric shape is sufficient to surround the solder joint 28, thereby providing a physical barrier that prevents contact between the encapsulation 26 and the solder joint 28.

[0024] Although the casing 30 surrounds the solder joint 28, a chamber or layer of air 38 exists between the solder joint 28 and the casing 30. The layer of air 38 prevents any stress that is imparted onto the casing 30 from the encapsulation 26 such that the stress is not transferred onto the solder joint 28 to prevent the transparent pane 18 from cracking. For example, the layer of air 38 prevents stress produced from differences in thermal expansion between the transparent pane 18 and the encapsulation 26 from being imparted onto the solder joint 28, because the solder joint 28 is not in contact with the encapsulation 26 or the casing 30. It should be appreciated that, when the transparent pane 18 is a glass pane, the layer of air 38 prevents a stress imparted on the casing 30 from the encapsulation 26 from being transferred onto the solder joint 28 to prevent the transparent pane 18 from cracking.

[0025] In one embodiment, the casing 30 is made of a polymeric material. The polymeric material may include thermoplastic polymers, thermoset polymers, or combinations thereof. Non-limiting examples of the polymeric material include silicones, nylons, polybutylene terephthalate, and the like. In one embodiment, an adhesive 40 may attach the casing 30 to the window assembly 10. Typically, the adhesive 40 attaches the casing 30 to the transparent pane 18, such that the casing 30 contacts the transparent pane 18. However, the adhesive 40 may also attach the casing 30 to the electrical conductor 20. Suitable adhesives are adhesives that provide adhesion to glass, such as pressure sensitive adhesives, urethanes, epoxies, acrylics, silicones, and the like.

[0026] In another embodiment, a mechanical mechanism may attach the casing 30 to the window assembly 10. In other words, the casing 30 may be geometrically configured to mechanically interlock with the connection element 22,

with the wire harness 16, or both. For example, the casing 30 may be geometrically configured to snap fit over the connection element 22, the wiring harness 16, or both. In yet another embodiment, the casing 30 includes one or more attachment features 42 that locates and/or secures the casing 30 to the connection element 22, the wiring harness 16, or both.

[0027] The window assembly 10 of the present invention includes the casing 30, which is advantageous because the transparent pane 18 typically has a lower coefficient of thermal expansion than the encapsulation 26, such as when the transparent pane 18 is glass. As such, if the casing 30 was not present to isolate the encapsulation 26 and the solder joint 28 (i.e., the encapsulation 26 is in direct contact with the solder joint 28) the differences in the coefficients of thermal expansion between the transparent pane 18 and the encapsulation 26 will impart a mechanical stress onto the transparent pane 18 through the solder joint 28. Imparting a mechanical stress onto the transparent pane 18 may cause the transparent pane 18 to crack. Additionally, imparting a mechanical stress onto the transparent pane 18 may separate the electrical conductor 20 and the terminal connector 24, thereby severing the electrical connection between the electrical conductor 20 and the power supply. As such, because the casing 30 isolates the solder joint 28 from the encapsulation 26, no mechanical stress is imparted onto the transparent pane 18 through the solder joint 28. To this end, the solder joint 28 is not prone to failure because the differences in the thermal expansion between the transparent pane 18 and the encapsulation 26 do not impart a stress on the solder joint 28. Likewise, when the window assembly 10 of the present invention includes the casing 30, the transparent pane 18 is not prone to cracking or fracturing. In addition, because the casing 30 seals the solder joint 28, water is unable to penetrate past the casing and contact the solder joint 28. As such,

not only is the solder joint 28 less prone to failure from mechanical stress, but the solder joint 28 is also less susceptible to corrosion.

[0028] The present invention has been described in an illustrative manner. It is to be understood that the terminology, which has been used, is intended to be in the nature of words of description rather than of limitation.

[0029] Many modifications and variations of the present invention are possible in light of the above teachings. Therefore, the present invention may be practiced other than as specifically described.

CLAIMS**WHAT IS CLAIMED IS:**

1. A window assembly (10) comprising:
 - a transparent pane (18);
 - an electrical conductor (20) contacting said transparent pane (18);
 - an electrical connection element (22) for energizing said electrical conductor (20);
 - an electrically conductive solder joint (28) between said electrical connection element (22) and said electrical conductor (20) for providing an electrical connection between said electrical connection element (22) and said electrical conductor (20);
 - an encapsulation (26) over said electrical connection element (22) and said electrical conductor (20); and
 - a casing (30) disposed between said encapsulation (26) and said electrical conductor (20) to prevent contact between said encapsulation (26) and said solder joint (28).
2. A window assembly (10) set forth in claim 1 wherein said casing (30) is set apart in substantially all areas to form a layer of air (38) between said encapsulation (26) and said solder joint (28) to prevent stress imparted on said casing (30) from said encapsulation (26) from being transferred to said solder joint (28) to prevent said transparent pane (18) from cracking.
3. A window assembly (10) as set forth in claim 1 wherein said casing (30) surrounds said solder joint (28).

4. A window assembly (10) as set forth in claim 1 wherein said casing (30) is made of a polymeric material.

5. A window assembly (10) as set forth in claim 1 including an adhesive (40) to attach said casing (30) to said transparent pane (18).

6. A window assembly (10) as set forth in claim 1 including a mechanical mechanism having an attachment feature (42) to attach said casing (30) to said electrical connection element (22).

7. A window assembly (10) as set forth in claim 1 wherein said electrical conductor (20) comprises a printed silver circuit.

8. A window assembly (10) as set forth in claim 1 wherein said transparent pane (18) comprises a glass pane.

9. A window assembly (10) as set forth in claim 1 wherein said encapsulation (26) is made of a polymeric material.

10. A window assembly (10) comprising:
a transparent pane (18);
an electrical conductor (20) contacting said transparent pane (18);
an electrical connection element (22) including a terminal connector (24) for electrical connection to said electrical conductor (20) for energizing said electrical conductor (20);

an electrically conductive solder joint (28) between said terminal connector (24) and said electrical conductor (20) for providing an electrical connection between said terminal connector (24) and said electrical conductor (20);

an encapsulation (26) disposed over said terminal connector (24) and said electrical conductor (20); and

a casing (30) disposed between said encapsulation (26) and said electrical conductor (22) to prevent contact between said encapsulation (26) and said solder joint (28) and forming a layer of air (38) between said encapsulation (26) and said solder joint (28) to prevent stress imparted on said casing (30) from said encapsulation (26) from being transferred to said solder joint (28) to prevent said transparent pane (18) from cracking.

11. A window assembly (10) as set forth in claim 10 wherein said casing (30) is made of a polymeric material.

12. A window assembly (10) as set forth in claim 10 wherein said encapsulation (26) is made of a polymeric material.

13. A window assembly (10) as set forth in claim 12 wherein said transparent pane (18) comprises a glass pane.

14. A window assembly (10) as set forth in claim 13 wherein said electrical conductor (20) comprises a printed silver circuit.

AMENDED CLAIMS

received by the International Bureau on 12 January 2015 (12.01.2015)

1. A window assembly (10) comprising:
 - a transparent pane (18);
 - an electrical conductor (20) contacting said transparent pane (18);
 - an electrical connection element (22) for energizing said electrical conductor (20);
 - an electrically conductive solder joint (28) between said electrical connection element (22) and said electrical conductor (20) for providing an electrical connection between said electrical connection element (22) and said electrical conductor (20);
 - an encapsulation (26) over said electrical connection element (22) and said electrical conductor (20); and
 - a casing (30) disposed between said encapsulation (26) and said electrical conductor (20) and contacting said encapsulation (26) and said transparent pane (18) to prevent contact between said encapsulation (26) and said solder joint (28).
2. A window assembly (10) set forth in claim 1 wherein said casing (30) is set apart in substantially all areas to form a layer of air (38) between said encapsulation (26) and said solder joint (28) to prevent stress imparted on said casing (30) from said encapsulation (26) from being transferred to said solder joint (28) to prevent said transparent pane (18) from cracking.
3. A window assembly (10) as set forth in claim 1 wherein said casing (30) surrounds said solder joint (28).

4. A window assembly (10) as set forth in claim 1 wherein said casing (30) is made of a polymeric material.

5. A window assembly (10) as set forth in claim 1 including an adhesive (40) to attach said casing (30) to said transparent pane (18).

6. A window assembly (10) as set forth in claim 1 including a mechanical mechanism having an attachment feature (42) to attach said casing (30) to said electrical connection element (22).

7. A window assembly (10) as set forth in claim 1 wherein said electrical conductor (20) comprises a printed silver circuit.

8. A window assembly (10) as set forth in claim 1 wherein said transparent pane (18) comprises a glass pane.

9. A window assembly (10) as set forth in claim 1 wherein said encapsulation (26) is made of a polymeric material.

10. A window assembly (10) comprising:
a transparent pane (18);
an electrical conductor (20) contacting said transparent pane (18);
an electrical connection element (22) including a terminal connector (24) for electrical connection to said electrical conductor (20) for energizing said electrical conductor (20);

an electrically conductive solder joint (28) between said terminal connector (24) and said electrical conductor (20) for providing an electrical connection between said terminal connector (24) and said electrical conductor (20);

an encapsulation (26) disposed over said terminal connector (24) and said electrical conductor (20); and

a casing (30) disposed between said encapsulation (26) and said electrical conductor (22) and contacting said encapsulation (26) and said transparent pane (18) to prevent contact between said encapsulation (26) and said solder joint (28) and forming a layer of air (38) between said encapsulation (26) and said solder joint (28) to prevent stress imparted on said casing (30) from said encapsulation (26) from being transferred to said solder joint (28) to prevent said transparent pane (18) from cracking.

11. A window assembly (10) as set forth in claim 10 wherein said casing (30) is made of a polymeric material.

12. A window assembly (10) as set forth in claim 10 wherein said encapsulation (26) is made of a polymeric material.

13. A window assembly (10) as set forth in claim 12 wherein said transparent pane (18) comprises a glass pane.

14. A window assembly (10) as set forth in claim 13 wherein said electrical conductor (20) comprises a printed silver circuit.

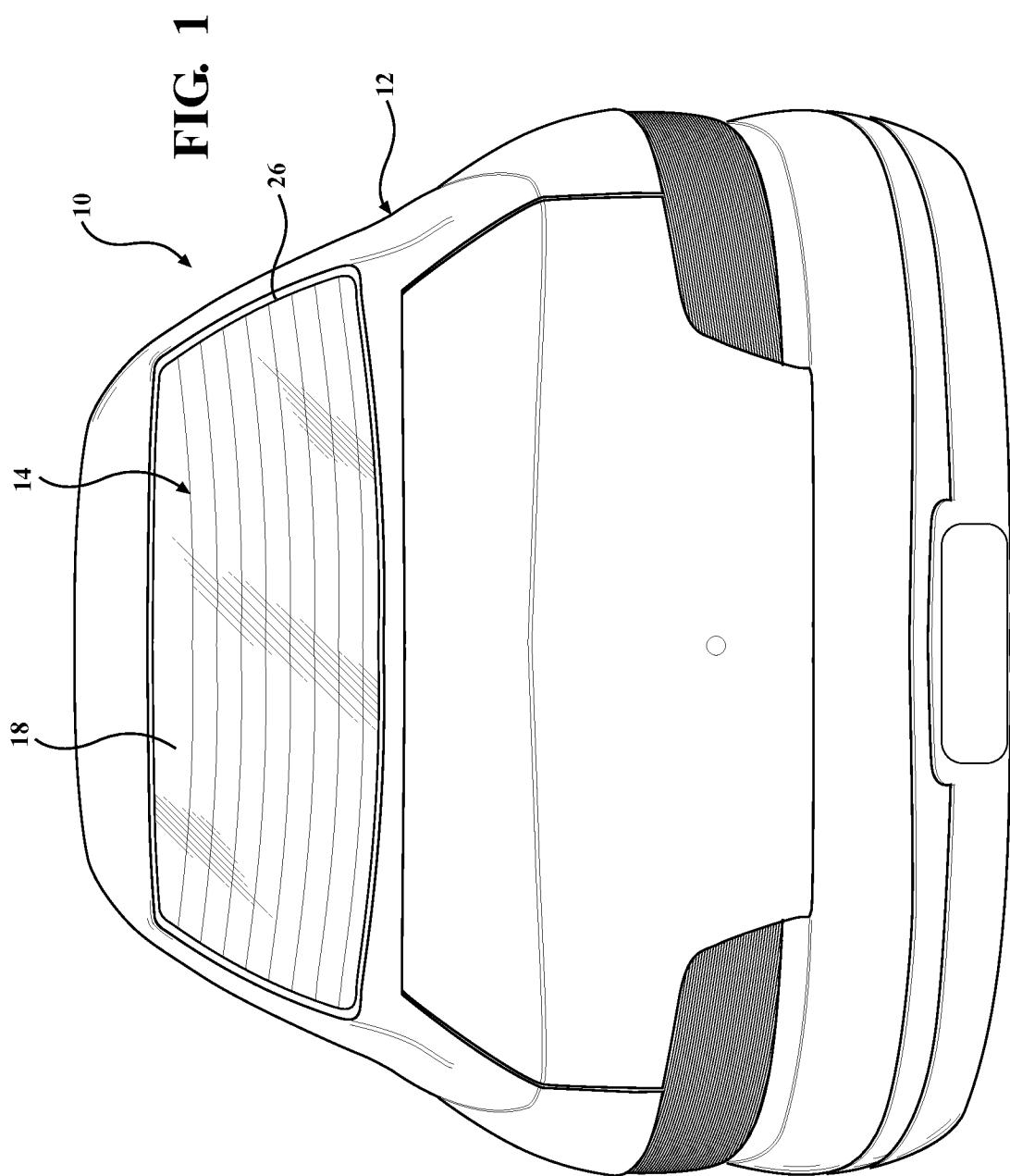
STATEMENT UNDER ARTICLE 19 (1)

After entry of this Amendment, claims 1 – 14 are pending in the application. Claims 1 and 10 are hereby amended. Claims 2 – 9 and 11 – 14 are unchanged.

Item V of Written Opinion:

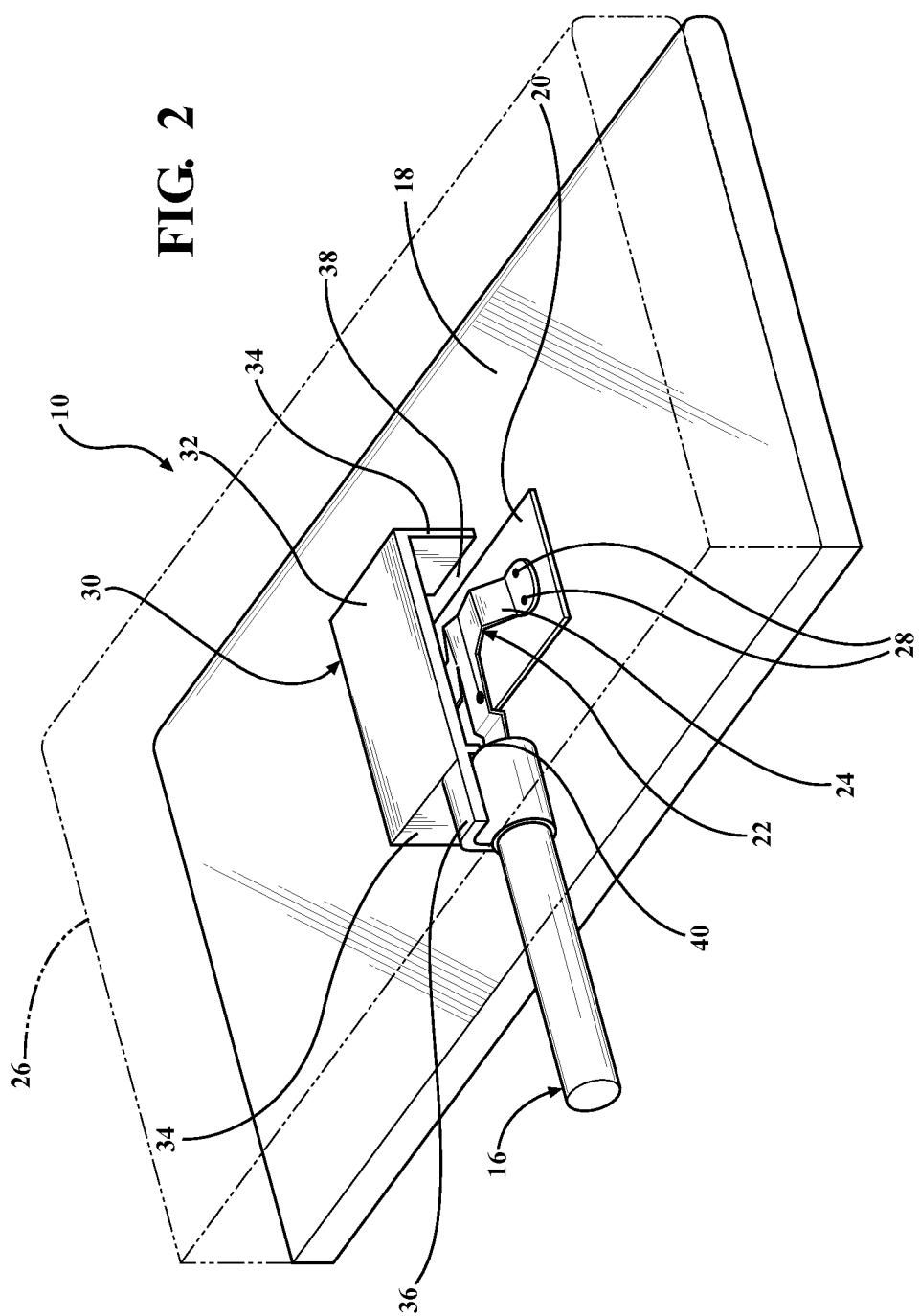
Applicants note, as stated in paragraph [0023] of the application, that the casing 30 has a top wall 32 and side walls 34 extending downwardly from the top wall 32 to engage the transparent pane 18. As stated in paragraph [0025], typically, the adhesive 40 attaches the casing 30 to the transparent pane 18, such that the casing 30 contacts the transparent pane 18. In addition, Applicants respectfully submit that D1 does not disclose a casing disposed between the encapsulation and the electrical conductor and contacting the encapsulation and the transparent pane to prevent contact between the encapsulation and the solder joint, which is now recited in independent claims 1 and 10 after entry of this Amendment. For these reasons, the Applicants submit that independent claims 1 and 10 and claims dependent thereon are novel and involve an inventive step.

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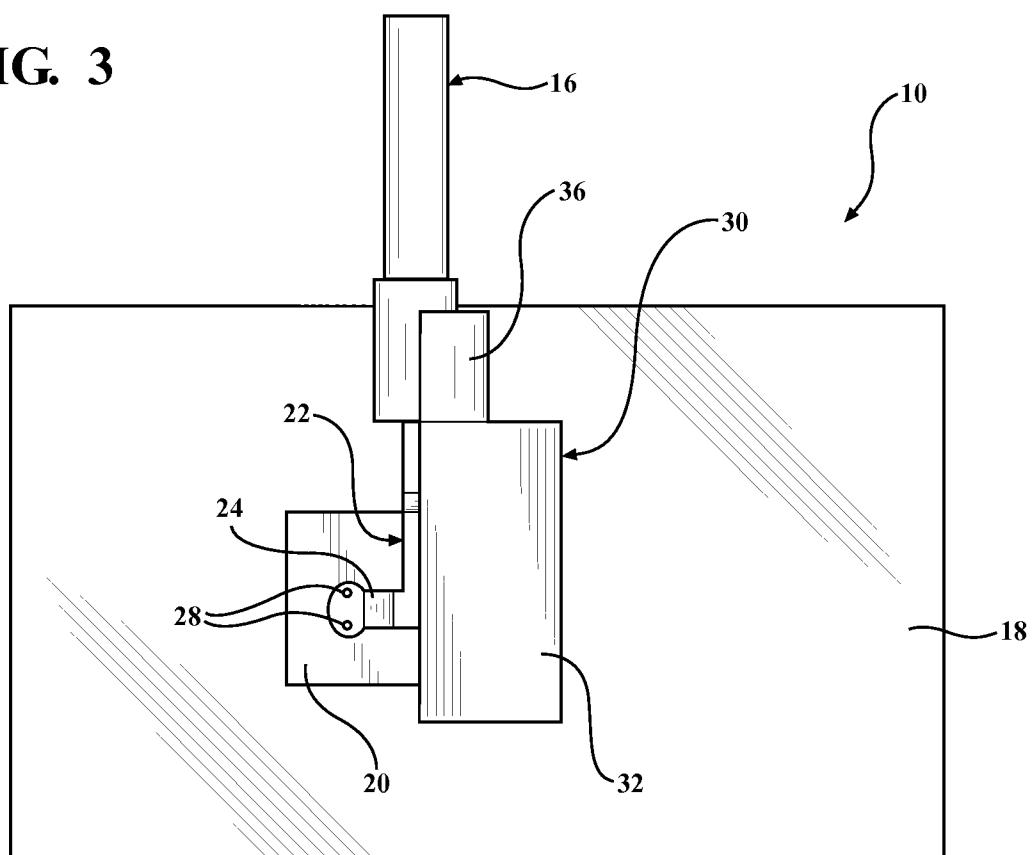
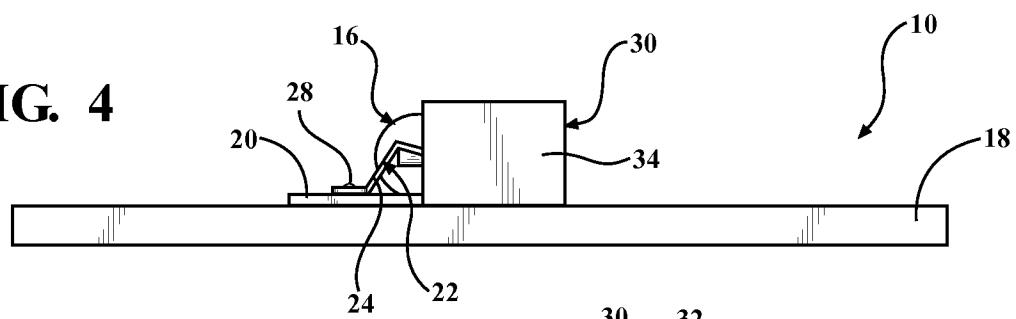
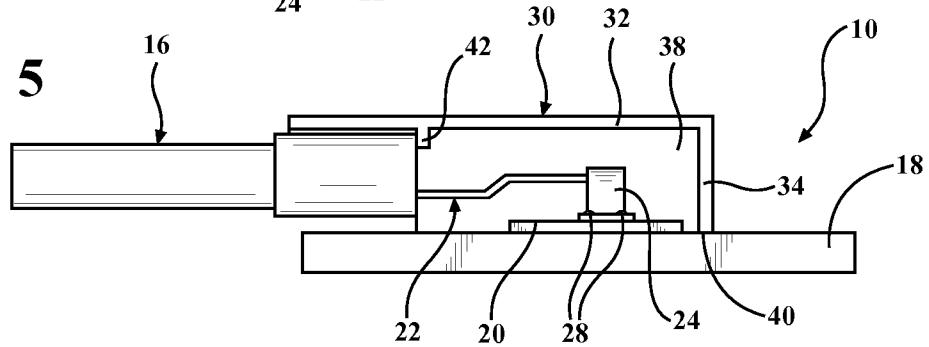


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FIG. 2



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FIG. 3**FIG. 4****FIG. 5**

INTERNATIONAL SEARCH REPORT

International application No
PCT/US2014/051216

A. CLASSIFICATION OF SUBJECT MATTER
INV. H01R4/02 B60J10/02 H05B3/84
ADD.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
H01R B60J H05B

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

EPO-Internal

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2012/091113 A1 (BENNETT DAN [US] ET AL) 19 April 2012 (2012-04-19) paragraphs [0039], [0046], [0061], [0062], [0065], [0066]; figure 13 -----	1-5,7-14
A	GB 2 192 023 A (PILKINGTON BROTHERS PLC [GB]) 31 December 1987 (1987-12-31) page 4, line 32 - line 34 page 4, line 45 - line 50 figure 8 -----	6



Further documents are listed in the continuation of Box C.



See patent family annex.

* Special categories of cited documents :

- "A" document defining the general state of the art which is not considered to be of particular relevance
- "E" earlier application or patent but published on or after the international filing date
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- "O" document referring to an oral disclosure, use, exhibition or other means
- "P" document published prior to the international filing date but later than the priority date claimed

"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art

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Date of the actual completion of the international search

Date of mailing of the international search report

7 November 2014

27/11/2014

Name and mailing address of the ISA/

European Patent Office, P.B. 5818 Patentlaan 2
NL - 2280 HV Rijswijk
Tel. (+31-70) 340-2040,
Fax: (+31-70) 340-3016

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Garcia Congosto, M

INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/US2014/051216

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
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